### System Lens Driver Series for Mobile Phone Cameras

# Parallel Interface Type Lens Drivers for Stepping Motor BD6360GUL

#### Description

The BD6360GUL motor driver provides 2 Full-ON Drive H-bridge channel.

It is offered in an ultra small functional lens system for use in an auto focus or zoom system using a stepping motor.

And It integrates a power supply and wave-shaping circuit for the photo-interrupter necessary in order to determine the location of the motor.

#### Features

BD6360GUL

- 1) Ultra-small chip size package : 2.1mm × 2.1mm × 0.55mm
- 2) Low ON-Resistance Power CMOS output : on high and low sides in total typ.  $1.00\Omega$
- 3) ESD resistance (Human Body Model) : 8kV
- 4) Built-in voltage-regulator circuit for photo-interrupter and comparator circuits with hysteresis for photo-interrupter output waveform
- 5) Input mode selection function (1.8V can be put into each control input terminal)
- 6) Built-in UVLO (Under Voltage Lockout Protection) function
- 7) Built-in TSD (Thermal Shut Down) circuit
- 8) Standby current consumption: 0µA Typ.

| Parameter                   | Symbol | Limit                            | Unit  |
|-----------------------------|--------|----------------------------------|-------|
| Power supply voltage        | VCC    | -0.3~+6.5                        | V     |
| Control input voltage       | VIN    | -0.3~VCC+0.3                     | V     |
| Power dissipation           | Pd     | 730 <sup>%1</sup>                | mW    |
| Operating temperature range | Topr   | -25~+85                          | °C    |
| Junction temperature        | Tjmax  | +150                             | °C    |
| Storage temperature         | Tstg   | -55~+150                         | °C    |
| H-bridge output current     | lout   | -500 <b>~</b> +500 <sup>%2</sup> | mA/ch |

●Absolute Maximum Ratings (Ta=+25°C)

\*1 Reduced by 5.84mW/°C over 25°C, when mounted on a glass epoxy board (50mm × 58mm × 1.75mm; 8 layers)

<sup>\*\*2</sup> Must not exceed Pd, ASO, or Tjmax of 150°C.

#### Operating Conditions

| Parameter               | Symbol | Limit                            | Unit  |
|-------------------------|--------|----------------------------------|-------|
| Power supply voltage    | VCC    | +2.3~+5.5                        | V     |
| Control input voltage   | VIN    | 0~VCC                            | V     |
| H-bridge output current | lout   | -400 <b>~</b> +400 <sup>涨3</sup> | mA/ch |

<sup>\*\*3</sup> Must not exceed Pd or ASO.

### BD6360GUL Electrical Characteristics (Unless otherwise specified Ta=25°C, VCC=3.0V)

|   |               | Limit        |      |      |      |  |
|---|---------------|--------------|------|------|------|--|
| Parameter                                   | Symbol        | Min.         | Тур. | Max. | Unit | Conditions                               |
| Overall                                     | L             |              |      |      | I.   | 1  |
| Circuit current<br>during standby operation | ICCST         | -            | 0    | 5    | μA   | PS=0V                                    |
| Circuit current                             | ICC           | -            | 1.1  | 1.8  | mA   | PS=3V with no signal, and no load        |
| Control input (VIN=IN1A, IN7                | 1B, IN2A, IN2 | 2B, SEL, PS) |      |      |      |  |
| High level input voltage                    | VINH          | 1.5          | -    | VCC  | V    |  |
| Low level input voltage                     | VINL          | 0            | -    | 0.5  | V    |  |
| High level input current                    | IINH          | 15           | 30   | 60   | μA   | VINH=3V, pull down resistance typ.100kΩ  |
| Low level input current                     | IINL          | -1           | 0    | -    | μA   | VINL=0V                                  |
| UVLO  |               |              |      |      |      |  |
| UVLO voltage                                | VUVLO         | 1.6          | -    | 2.2  | V    |  |
| Photo-interrupter (PI) compa                | rator         |              |      |      |      |  |
| Input bias current                          | IBIPI         | -3           | 0    | 3    | μA   |  |
| Output low level voltage                    | VLOPI         | 0            | -    | 0.5  | V    | lo=+1mA                                  |
| Output igh level voltage                    | VHIPI         | VCC-0.5      | -    | VCC  | V    | lo=-1mA                                  |
| Threshold voltage                           | VTHPI         | 1.2          | 1.3  | 1.4  | V    | Lo→Hi threshold voltage                  |
| Hysteresis voltage                          | VHYSPI        | 200          | 300  | 400  | mV   | Hi→Lo threshold voltage VTHPI-VHYSPI     |
| Photo-interrupter (PI) regulation           | tor           |              |      |      |      |  |
| ON-Resistance                               | RONSW         | -            | -    | 10   | Ω    | lo=-30mA                                 |
| OFF current                                 | ILSW          | -1.0         | 0    | -    | μA   | BIAS=0V                                  |
| Full-ON Drive block (ch1 and                | d ch2)        |              |      |      |      |  |
| Output ON-Resistance                        | RON           | -            | 1.00 | 1.25 | Ω    | Io=+400mA on high and low sides in total |
| Output AC characteristic                    | -             |              |      |      |      |  |
| Turn-on time                                | -             | -            | -    | 2.0  | μs   | lo=±400mA                                |
| Turn-off time                               | toff          | -            | 0.08 | 0.5  | μs   | lo=±400mA                                |
| Rise time                                   | tr            | 0.1          | 0.15 | 1.0  | μs   | lo=±400mA                                |
| Fall time                                   | tf            | -            | 0.03 | 0.2  | μs   | $lo=\pm 400 \text{mA}$                   |



Fig.1 BD6360GUL I/O Switching Waveform



Fig.2 BD6360GUL Power Dissipation Reduction

#### •Electrical Characteristic Diagrams



Fig.7 BIAS Output Voltage

1)BD6360GUL Block Diagram, Application Circuit Diagram, Pin Arrangement and Pin Function Table



Fig.8 BD6360GUL Application Circuit Diagram

|   | 1     | 2             | 3    | 4    |
|---|-------|---------------|------|------|
| A | OUT2B | CIN           | COUT | BIAS |
| В | OUT2A | INDEX<br>POST | IN2A | VCC  |
| С | OUT1B | IN1B          | IN2B | SEL  |
| D | OUT1A | GND           | IN1A | PS   |

Fig.9 BD6360GUL Pin Arrangement (Top View)

#### Pin name Function No. OUT2B H-bridge output pin ch2 B 1A 2A CIN Comparator circuits with output waveform input pin ЗA COUT Comparator circuits with output waveform output pin 4A BIAS Voltage-regulator for photo-interrupter 1B OUT2A H-bridge output pin ch2 A 2B 3B IN2A Control input pin ch2 A 4B VCC Power supply pin 1C OUT1B H-bridge output pin ch1 B 2C IN1B Control input pin ch1 B 3C IN2B Control input pin ch2 B 4C SEL Input mode selection pin ch1 1D OUT1A H-bridge output pin ch1 A 2D GND Ground pin 3D IN1A Control input pin ch1 A

#### BD6360GUL Pin Function Table

4D

PS

Power-saving pin

#### ●I/O Truth Table

#### BD6360GUL I/O Truth Table (x=1or2)

| in a da | INPUT |     |      | OUTPUT |       |                  |                  |
|---------|-------|-----|------|--------|-------|------------------|------------------|
| mode    | PS    | SEL | INxA | INxB   | OUTxA | OUTxB            | Output mode      |
|         |       |     | L    | Х      | Z     | Z                | Standby          |
| EN/IN   |       | L   | Н    | L      | Н     | L                | Forward rotation |
|         |       |     | Н    | Н      | L     | Н                | Reverse rotation |
|         | Н     |     | L    | L      | Z     | Z                | Standby          |
| INI/INI |       | L   | Н    | L      | Н     | Reverse rotation |                  |
| IN/IN   | H     | Н   | L    | Н      | L     | Forward rotation |                  |
|         |       |     |      | н      | н     | L                | L                |
| -       | L     | Х   | Х    | Х      | Z     | Z                | Standby          |

At forward rotation, current flows from OUTxA to OUTxB. At reverse rotation, current flows form OUTxB to OUTxA. L: Low, H: High, X: Don't care, Z: Hi impedance

#### Function Explanation

1) Power save function

When the L voltage is applied the PS pin, the IC's inside circuit stop, and when 0V applied, the circuit current became  $0\mu A(Typ.)$ , especially.

When the IC drive, Serial input while the PS pin applied H voltage. (See the electrical characteristics; P.2/8)

2) Control Input Pin

IN1A, IN1B, IN2A, IN2B, SEL pins

The IN1A, IN1B, IN2A, IN2B are used to program and control the motor drive modes.

And, when the L voltage is applied to the SEL pin, the I/O logic can be set to EN(Enable)/IN mode, when the H voltage is applied to the one, the I/O logic can be set to IN/IN mode. (See the electrical characteristics; P2/8, and the I/O Truth Table; P5/8)

3) H-bridge on the output stage
 Specify maximum current applied to the H-bridge within the operating range, in consideration of power dissipation.
 (See the Operating Conditions; P.1/8)

# Photo-interrupter regulator Pay attention to the ON resistance with regard to the power source of the Photo interrupter. (See the electrical characteristics; P.2/8)

5) The wave-shaping circuit convert

The wave-shaping circuit convert the distorted output signals from the photo-interrupter into clean rectangular waves, then outputs them to the DSP.

A hysteresis function is included that blocks output signal chatter caused by input signal noise.





#### ●I/O Circuit Diagram



Fig.11 BD6360GUL I/O Circuit Diagram (Resistance values are typical ones)

#### Operation Notes

1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings, such as the applied voltage (VCC) or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

- Storage temperature range (Tstg)
   As long as the IC is kept within this range, there should be no problems in the IC's performance. Conversely, extreme temperature changes may result in poor IC performance, even if the changes are within the above range.
- 3) Power supply and wiring

Be sure to connect the power terminals outside the IC. Do not leave them open. Because a return current is generated by a counter electromotive force of the motor, take necessary measures such as putting a Capacitor between the power source and the ground as a passageway for the regenerative current. Be sure to connect a Capacitor of proper capacitance  $(0.1\mu F to 10\mu F)$  between the power source and the ground at the foot of the IC, and ensure that there is no problem in properties of electrolytic Capacitors such as decrease in capacitance at low temperatures. When the connected power source does not have enough current absorbing capability, there is a possibility that the voltage of the power source line increases by the regenerative current an exceeds the absolute maximum rating of this product and the peripheral circuits.

Therefore, be sure to take physical safety measures suc h as putting a zener diode for a voltage clamp between the power source an the ground.

For this IC with a part consists of the CMOS block, it is possible that rush current may flow instantaneously due to the unstable internal logic. Therefore, give special consideration to power coupling capacitance, width of power and ground wirings, and routing of wiring.

4) Ground terminal and wiring

The potential at GND terminals should be made the lowest under any operating conditions. Ensure that there are no terminals where the potentials are below the potential at GND terminals, including the transient phenomena. Use short and thick power source and ground wirings to ensure low impedance.

5) Thermal design

Use a proper thermal design that allows for a sufficient margin of the power dissipation (Pd) at actual operating conditions.

6) Pin short and wrong direction assembly of the device.

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error or if positive and ground power supply terminals are reversed. The IC may also be damaged if pins are shorted together or are shorted to other circuit's power lines.

- 7) Avoiding strong magnetic field Malfunction may occur if the IC is used around a strong magnetic field.
- 8) ASO

Ensure that the output transistors of the motor driver are not driven under excess conditions of the absolute maximum ratings and ASO.

9) TSD (Thermal Shut Down) circuit

If the junction temperature (Tjmax) reaches 175°C, the TSD circuit will operate, and the coil output circuit of the motor will open. There is a temperature hysterics of approximately 25°C. The TSD circuit is designed only to shut off the IC in order to prevent runaway thermal operation. It is not designed to protect the IC or guarantee its operation. The performance of the IC's characteristics is not guaranteed and it is recommended that the device is replaced after the TSD is activated.

10) Testing an application board

When testing the IC on an application board, connecting a Capacitor to a pin with low impedance subjects the IC to stress. Always discharge Capacitors after each process or step. Always turn the IC's power supply off before connecting it to, or removing it from a jig or fixture, during the inspection process. Ground the IC during assembly steps as an antistatic measure. Use similar precaution when transporting and storing the IC.

11) Regarding the input pin of the IC

This monolithic IC contains  $P^+$  isolation and P substrate layers between adjacent elements to keep them isolated. P-N junctions are formed at the intersection of these P layers with the N layers of other elements, creating a parasitic diode or transistor. For example, the relation between each potential is as follows:

When GND > Pin A, the P-N junction operates as a parasitic diode.

When GND > Pin B, the P-N junction operates as a parasitic diode and transistor.

Parasitic elements can occur inevitably in the structure of the IC. The operation of parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Accordingly, methods by which parasitic elements operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin, should not be used.



Fig.12 Example of Simple IC Architecture

Selecting a Model Name when Ordering





The contents described herein are correct as of April, 2008

The contents described herein are subject to change without notice. For updates of the latest information, please contact and confirm with ROHM CO. LTD.

Any part of this application note must not be duplicated or copied without our permission.

Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.

Any data, including, but not limited to application circuit diagrams and information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.

• Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by ROHM CO., LTD. is granted to any such buyer.

The products described herein utilize silicon as the main material.
 The products described herein are not designed to be X ray proof.

The products listed in this catalog are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

#### Contact us for further information about the products.





## ROHM CO., LTD.

21, Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585, Japan TEL: +81-75-311-2121 FAX: +81-75-315-0172 URL http: // www. rohm. com

LSI Business Promotion Dept.

Published by

| San Diego      | TEL: +1-858-625-3630   | FAX: +1-858-625-3670   |
|----------------|------------------------|------------------------|
| Atlanta        | TEL: +1-770-754-5972   | FAX: +1-770-754-0691   |
| Boston         | TEL: +1-978-371-0382   | FAX: +1-928-438-7164   |
| Chicago        | TEL: +1-847-368-1006   | FAX: +1-847-368-1008   |
| Dallas         | TEL: +1-469-287-5366   | FAX: +1-469-362-7973   |
| Denver         | TEL: +1-303-708-0908   | FAX: +1-303-708-0858   |
| Detroit        | TEL: +1-248-348-9920   | FAX: +1-248-348-9942   |
| Nashville      | TEL: +1-615-620-6700   | FAX: +1-615-620-6702   |
| Mexico         | TEL: +52-33-3123-2001  | FAX: +52-33-3123-2002  |
| Düsseldorf     | TEL: +49-2154-9210     | FAX: +49-2154-921400   |
| Munich         | TEL: +49-8161-48310    | FAX: +49-8161-483120   |
| Stuttgart      | TEL: +49-711-72723710  | FAX: +49-711-72723720  |
| France         | TEL: +33-1-5697-3060   | FAX: +33-1-5697-3080   |
| United Kingdom | TEL: +44-1-908-306700  | FAX: +44-1-908-235788  |
| Denmark        | TEL: +45-3694-4739     | FAX: +45-3694-4789     |
| Barcelona      | TEL: +34-9375-24320    | FAX: +34-9375-24410    |
| Hungary        | TEL: +36-1-4719338     | FAX: +36-1-4719339     |
| Poland         | TEL: +48-22-5757213    | FAX: +48-22-5757001    |
| Russia         | TEL: +7-95-980-6755    | FAX: +7-95-937-8290    |
| Seoul          | TEL: +82-2-8182-700    | FAX: +82-2-8182-715    |
| Masan          | TEL: +82-55-240-6234   | FAX: +82-55-240-6236   |
| Dalian         | TEL: +86-411-8230-8549 | FAX: +86-411-8230-8537 |
| Beijing        | TEL: +86-10-8525-2483  | FAX: +86-10-8525-2489  |
| Tianjin        | TEL: +86-22-23029181   | FAX: +86-22-23029183   |
|                |                        |                        |

Shanghai Hangzhou Nanjing Ningbo Qingdao Suzhou Wuxi Wuxi Shenzhen Dongguan Fuzhou Guangzhou Huizhou Xiamen Zhuhai Hong Kong Taipei Kaohsiung Singapore Philippines Thailand Kuala Lumpu Penang Kyoto Yokohama

| TEL: +86-21-6279-2727  | FAX: +86-21-6247-2066  |
|------------------------|------------------------|
| TEL: +86-571-87658072  | FAX: +86-571-87658071  |
| TEL: +86-25-8689-0015  | FAX: +86-25-8689-0393  |
| TEL: +86-574-87654201  | FAX: +86-574-87654208  |
| TEL: +86-532-5779-312  | FAX:+86-532-5779-653   |
| TEL: +86-512-6807-1300 | FAX: +86-512-6807-2300 |
| TEL: +86-510-82702693  | FAX: +86-510-82702992  |
| TEL: +86-755-8307-3008 | FAX: +86-755-8307-3003 |
| TEL: +86-769-8393-3320 | FAX: +86-769-8398-4140 |
| TEL: +86-591-8801-8698 | FAX: +86-591-8801-8690 |
| TEL: +86-20-8364-9796  | FAX: +86-20-8364-9707  |
| TEL: +86-752-205-1054  | FAX: +86-752-205-1059  |
| TEL: +86-592-238-5705  | FAX: +86-592-239-8380  |
| TEL: +86-756-3232-480  | FAX: +86-756-3232-460  |
| TEL: +852-2-740-6262   | FAX: +852-2-375-8971   |
| TEL: +886-2-2500-6956  | FAX: +886-2-2503-2869  |
| TEL: +886-7-237-0881   | FAX: +886-7-238-7332   |
| TEL: +65-6332-2322     | FAX: +65-6332-5662     |
| TEL: +63-2-807-6872    | FAX: +63-2-809-1422    |
| TEL: +66-2-254-4890    | FAX: +66-2-256-6334    |
| TEL: +60-3-7958-8355   | FAX: +60-3-7958-8377   |
| TEL: +60-4-2286453     | FAX: +60-4-2286452     |
| TEL: +81-75-365-1218   | FAX: +81-75-365-1228   |
| TEL: +81-45-476-2290   | FAX: +81-45-476-2295   |

Catalog No.08T102A '08.4 ROHM ©